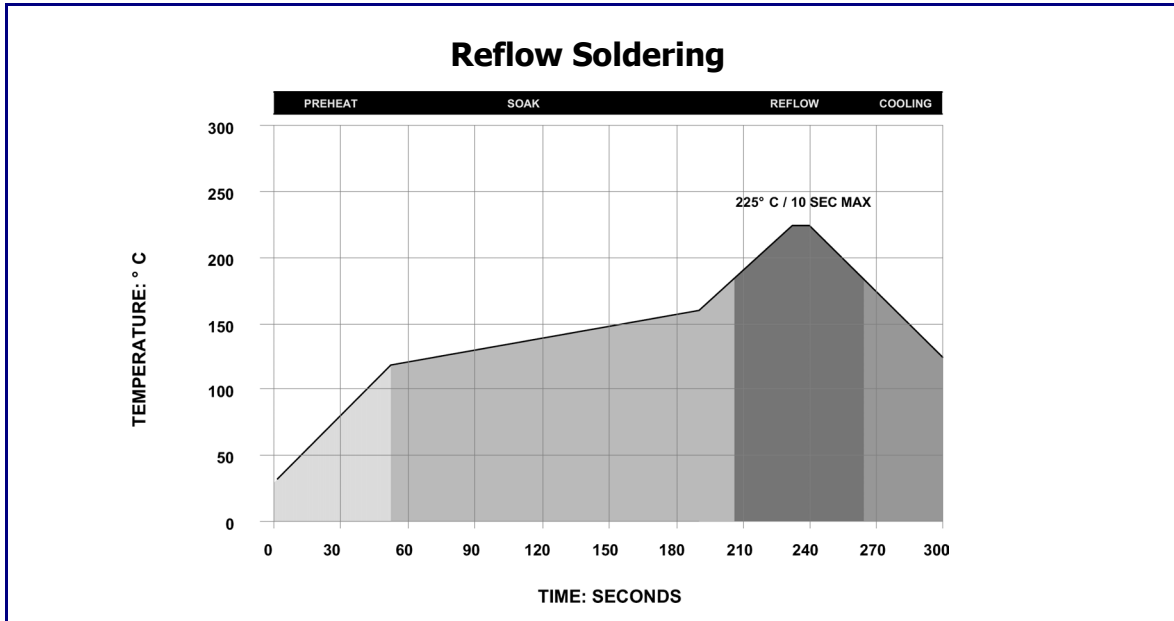
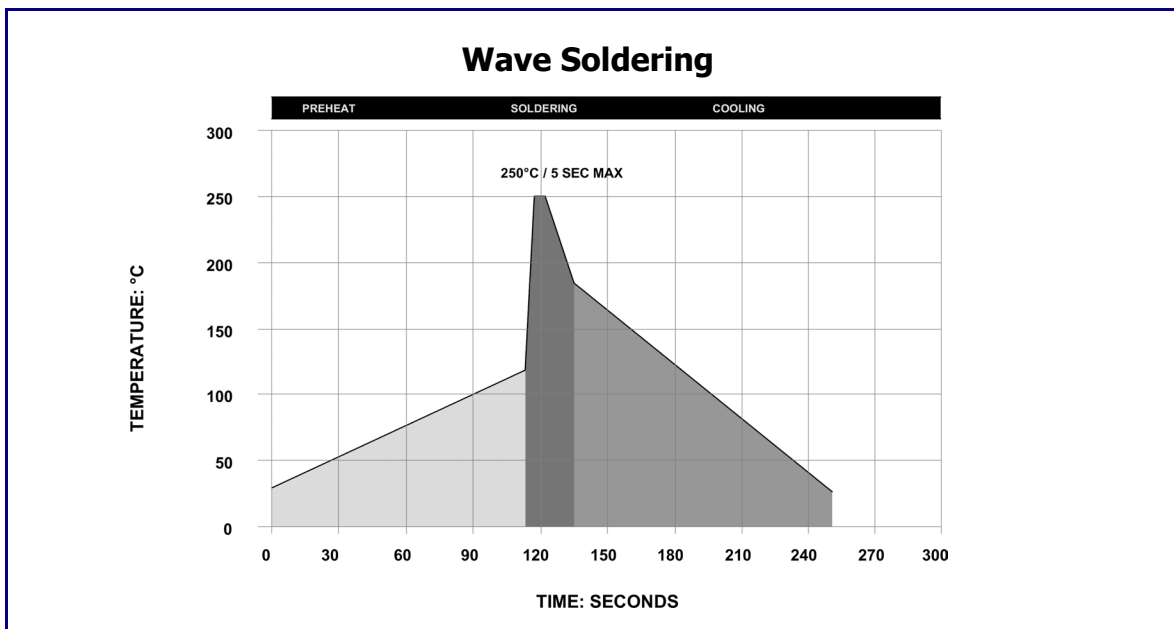


HALO Electronics recommends the following reflow and wave soldering profiles for processing its surface mount and through-hole products.



Maximum peak temperature (225°C) shall not exceed 10 seconds.
Maximum duration of temperature above 183°C shall not exceed 90 seconds.
Maximum ramp rate 3°C per second.



Maximum dwell time in the solder wave (250°C) shall not exceed 5 seconds.